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October 2013

GBPC 12, 15, 25, 35 SERIES Bridge Rectifiers (Glass Passivated)

Features

- Integrally molded heat-sink provided very low thermal resistance for maximum heat dissipation.
- Surge Overload Ratings from 300 A to 400 A.
- Isolated voltage from case to lead over 2500 V.
- UL certified, UL #E258596
- Terminals Finish Material Silver (Solderable per MIL-STD-202, Method 208 for the wire type GBPC-W package)
 Nickel for GBPC package.

1

Suffix "W"

• Wire Lead Structure

Suffix "M"

• Terminal Location Face to Face









GBPC-W



Ordering Informations

| Part Number | Marking | Package | Packing Method |
|-------------|------------|-----------|----------------|
| GBPC12005 | GBPC12005 | | |
| GBPC1201 | GBPC1201 | | |
| GBPC1202 | GBPC1202 | | |
| GBPC1204 | GBPC1204 | | |
| GBPC1206 | GBPC1206 | | |
| GBPC1208 | GBPC1208 | | |
| GBPC1210 | GBPC1210 | | |
| GBPC15005 | GBPC15005 | | |
| GBPC1501 | GBPC1501 | | |
| GBPC1502 | GBPC1502 | | |
| GBPC1504 | GBPC1504 | | |
| GBPC1506 | GBPC1506 | | |
| GBPC1508 | GBPC1508 | | |
| GBPC1510 | GBPC1510 | CDDC 41 | |
| GBPC25005 | GBPC25005 | GBPC 4L | |
| GBPC2501 | GBPC2501 | | |
| GBPC2502 | GBPC2502 | | |
| GBPC2504 | GBPC2504 | | |
| GBPC2506 | GBPC2506 | | |
| GBPC2508 | GBPC2508 | | Dulle |
| GBPC2510 | GBPC2510 | | Bulk |
| GBPC35005 | GBPC35005 | | |
| GBPC3501 | GBPC3501 | | |
| GBPC3502 | GBPC3502 | | |
| GBPC3504 | GBPC3504 | | |
| GBPC3506 | GBPC3506 | 1 | |
| GBPC3508 | GBPC3508 | | |
| GBPC3510 | GBPC3510 | | |
| GBPC1201W | GBPC1201W | | |
| GBPC1202W | GBPC1202W | | |
| GBPC1204W | GBPC1204W | | |
| GBPC1206W | GBPC1206W | | |
| GBPC1208W | GBPC1208W | | |
| GBPC1210W | GBPC1210W | CPDC W 4I | |
| GBPC15005W | GBPC15005W | GBPC-W 4L | |
| GBPC1501W | GBPC1501W | | |
| GBPC1502W | GBPC1502W | | |
| GBPC1504W | GBPC1504W | | |
| GBPC1506W | GBPC1506W | | |
| GBPC1508W | GBPC1508W | | |

Ordering Informations (continued)

| Part Number | Marking | Package | Packing Method |
|-------------|------------|-----------|----------------|
| GBPC1510W | GBPC1510W | | |
| GBPC25005W | GBPC25005W | | |
| GBPC2501W | GBPC2501W | | |
| GBPC2502W | GBPC2502W | | |
| GBPC2504W | GBPC2504W | | |
| GBPC2506W | GBPC2506W | | |
| GBPC2508W | GBPC2508W | | |
| GBPC2510W | GBPC2510W | GBPC-W 4L | Bulk |
| GBPC35005W | GBPC35005W | | |
| GBPC3501W | GBPC3501W | | |
| GBPC3502W | GBPC3502W | | |
| GBPC3504W | GBPC3504W | | |
| GBPC3506W | GBPC3506W | | |
| GBPC3508W | GBPC3508W | | |
| GBPC3510W | GBPC3510W | | |

Absolute Maximum Ratings(1)

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at $T_A = 25$ °C unless otherwise noted.

| Cumbal | Parameter | | Value | | | | | | | Unito |
|--------------------|---|--------|-------------|-----|-----|-----|-----|-----|------|-------|
| Symbol | | | 005 | 01 | 02 | 04 | 06 | 08 | 10 | Units |
| V_{RRM} | Maximum Repetitive Reverse Volt | age | 50 | 100 | 200 | 400 | 600 | 800 | 1000 | V |
| V _{RMS} | Maximum RMS Bridge Input Volta | ge | 35 | 70 | 140 | 280 | 420 | 560 | 700 | V |
| V_{R} | DC Reverse Voltage (Rated V _R) | | 50 | 100 | 200 | 400 | 600 | 800 | 1000 | V |
| | | GBPC12 | 12 | | | | | | | |
| | Average Rectified Forward | GBPC15 | 15 | | | | | A | | |
| I _{F(AV)} | Current at T _C = 55°C | GBPC25 | 25 | | | | | | | |
| | | GBPC35 | 35 | | | | | | | |
| I _{FSM} | Non-Repetitive Peak Forward GBPC12, Surge Current 15, 25 | | 300 | | | | | Α | | |
| | 8.3ms Single Half-Sine-Wave GBP0 | | 400 | | | | | Α | | |
| T _{STG} | Storage Temperature Range | | -55 to +150 | | | | | °C | | |
| TJ | Operating Junction Temperature | | -55 to +150 | | | | | °C | | |

Note:

1. These ratings are limiting values above which the serviceability of any semiconductor device may by impaired.

Thermal Characteristics

Values are at $T_A = 25^{\circ}C$ unless otherwise noted.

| Symbol | Parameter | Value | Units |
|-----------------|---|-------|-------|
| P _D | Power Dissipation | 83.3 | W |
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case ⁽²⁾ | 1.5 | °C/W |

Note:

2. With Heatsink.

Electrical Characteristics

Values are at $T_A = 25$ °C unless otherwise noted.

| Symbol | Parameter | Test Co | Test Conditions Value | | Units |
|------------------|--|---------------------------|-----------------------|----------------|--------------------|
| | | 6.0 A | GBPC12 | | V |
| V | Forward Voltage Drop, per bridge | 7.5 A | GBPC15 | 1.1 (Max) | |
| V _F | | 12.5 A | GBPC25 | | |
| | | 17.5 A | GBPC35 | | |
| /1- | Reverse Current, per element at Rated V _R | $T_A = 25^{\circ}C$ | | 25°C 5.0 (Max) | |
| I _R | Reverse Current, per element at Nated VR | $T_A = 125^{\circ}$ | 0 | 500 (Max) | μΑ |
| l ² t | Rating for Fusing t < 8.35 ms | GBPC12, | 15, 25 | 375 | A ² Sec |
| 1 (| Rating for Fusing (< 6.55 ms | GBPC35 | | 660 | A ² Sec |
| _ | Total Capacitance, per leg | e, per leg GBPC12, 15, 25 | | 180 | pF |
| C _T | $V_R = 4.0 \text{ V}$ f = 1.0 MHz | GBPC35 | | 200 | pF |

Typical Performance Characteristics

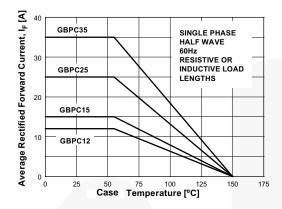


Figure 1. Forward Current Derating Curve

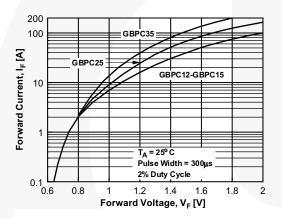


Figure 3. Forward Voltage Characteristics

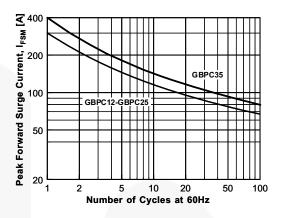


Figure 2. Non-Repetitive Surge Current

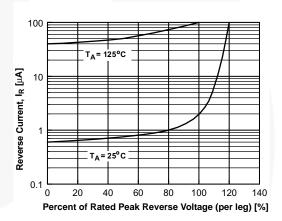
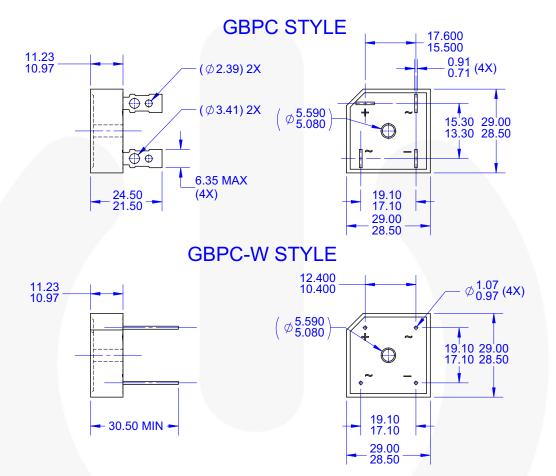


Figure 4. Reverse Current vs. Reverse Voltage

Physical Dimension

GBPC



NOTES:

- A. THIS PACKAGE DOES NOT CONFORM TO ANY STANDARDS.
 B. ALL DIMENSIONS ARE IN MILLIMETERS.
- D. ALL DIMENSIONS ARE IN MILLIMETERS.
 C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR PROTRUSIONS.
 D. FAIRCHILDSEMICONDUCTOR
 E. DRAWING FILE NAME: MKT-GBPC04A REV3

Figure 5. 4-TERMINAL, COMBINATION GBPC AND GBPC-W (ACTIVE)

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